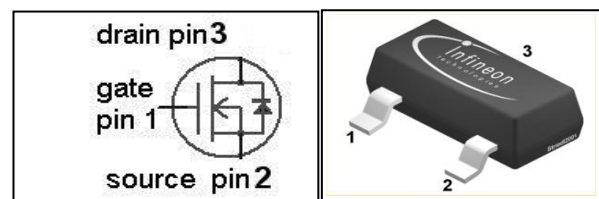


**SIPMOS<sup>®</sup> Small-Signal-Transistor**
**Features**

- N-channel
- Depletion mode
- $dv/dt$  rated
- Available with  $V_{GS(th)}$  indicator on reel
- Pb-free lead-plating; RoHS compliant
- Halogen-free according to AEC61249-2-21
- Qualified according to AEC Q101

**Product Summary**

$V_{DS}$	100	V
$R_{DS(on),max}$	12	$\Omega$
$I_{DSS,min}$	0.09	A

**PG-SOT-23**


Type	Package	Pb-free	Tape and Reel Information	Marking
BSS169	PG-SOT-23	Yes	H6327: 3000 pcs/reel	SFs
BSS169	PG-SOT-23	Yes	H6906: 3000 pcs/reel sorted in $V_{GS(th)}$ bands <sup>1)</sup>	SFs

**Maximum ratings, at  $T_j=25\text{ °C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	$I_D$	$T_A=25\text{ °C}$	0.17	A
		$T_A=70\text{ °C}$	0.14	
Pulsed drain current	$I_{D,pulse}$	$T_A=25\text{ °C}$	0.68	
Reverse diode $dv/dt$	$dv/dt$	$I_D=0.19\text{ A}$ , $V_{DS}=20\text{ V}$ , $di/dt=200\text{ A}/\mu\text{s}$ , $T_{j,max}=150\text{ °C}$	6	kV/ $\mu\text{s}$
Gate source voltage	$V_{GS}$		$\pm 20$	V
ESD Class		JESD22-A114-HBM	Class 0	
Power dissipation	$P_{tot}$	$T_A=25\text{ °C}$	0.36	W
Operating and storage temperature	$T_j$ , $T_{stg}$		-55 ... 150	$^{\circ}\text{C}$
IEC climatic category; DIN IEC 68-1			55/150/56	

<sup>1)</sup> see table on next page and diagram 11

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Thermal characteristics**

Thermal resistance, junction - ambient	$R_{thJA}$	minimal footprint	-	-	250	K/W
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**Electrical characteristics, at  $T_j=25\text{ °C}$ , unless otherwise specified**
**Static characteristics**

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=-10\text{ V}, I_D=250\text{ }\mu\text{A}$	100	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=3\text{ V}, I_D=50\text{ }\mu\text{A}$	-2.9	-2.2	-1.8	
Drain-source cutoff current	$I_{D(off)}$	$V_{DS}=100\text{ V},$ $V_{GS}=-10\text{ V}, T_j=25\text{ °C}$	-	-	0.1	$\mu\text{A}$
		$V_{DS}=100\text{ V},$ $V_{GS}=-10\text{ V}, T_j=125\text{ °C}$	-	-	10	
Gate-source leakage current	$I_{GSS}$	$V_{GS}=20\text{ V}, V_{DS}=0\text{ V}$	-	-	10	nA
On-state drain current	$I_{DSS}$	$V_{GS}=0\text{ V}, V_{DS}=10\text{ V}$	90	-	-	mA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=0\text{ V}, I_D=0.05\text{ A}$	-	5.3	12	$\Omega$
		$V_{GS}=10\text{ V}, I_D=0.19\text{ A}$	-	2.9		
Transconductance	$g_{fs}$	$ V_{DS} >2 I_D R_{DS(on)max},$ $I_D=0.15\text{ A}$		0.20	-	S

**Threshold voltage  $V_{GS(th)}$  sorted in bands<sup>2)</sup>**

J	$V_{GS(th)}$	$V_{DS}=3\text{ V}, I_D=50\text{ }\mu\text{A}$	-2	-	-1.8	V
K			-2.15	-	-1.95	
L			-2.3	-	-2.1	
M			-2.45	-	-2.25	
N			-2.6	-	-2.4	

<sup>2)</sup> Each reel contains transistors out of one band whose identifying letter is printed on the reel label. A specific band cannot be ordered separately.

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Dynamic characteristics**

Input capacitance	$C_{iss}$	$V_{GS}=-10\text{ V}, V_{DS}=25\text{ V},$ $f=1\text{ MHz}$	-	51	68	pF
Output capacitance	$C_{oss}$		-	9	13	
Reverse transfer capacitance	$C_{rss}$		-	4	7	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=50\text{ V},$ $V_{GS}=-3\dots 7\text{ V},$ $I_D=0.12\text{ A}, R_{G,ext}=6\ \Omega$	-	2.9	4.2	ns
Rise time	$t_r$		-	2.7	4.0	
Turn-off delay time	$t_{d(off)}$		-	11	17	
Fall time	$t_f$		-	27	40	

**Gate Charge Characteristics**

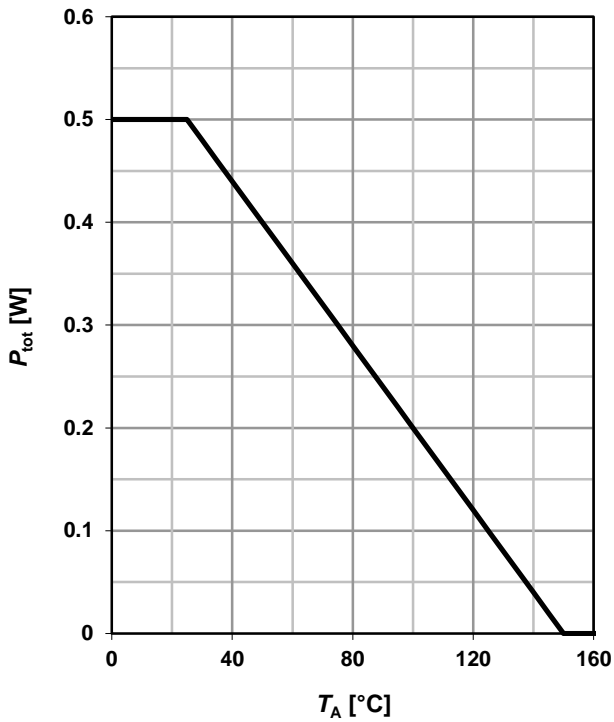
Gate to source charge	$Q_{gs}$	$V_{DD}=80\text{ V}, I_D=0.12\text{ A},$ $V_{GS}=-3\text{ to }7\text{ V}$	-	0.12	0.16	nC
Gate to drain charge	$Q_{gd}$		-	0.9	1.4	
Gate charge total	$Q_g$		-	2.1	2.8	
Gate plateau voltage	$V_{plateau}$		-	-0.43	-	V

**Reverse Diode**

Diode continuous forward current	$I_S$	$T_A=25\text{ }^\circ\text{C}$	-	-	0.19	A
Diode pulse current	$I_{S,pulse}$		-	-	0.76	
Diode forward voltage	$V_{SD}$	$V_{GS}=-10\text{ V}, I_F=0.19\text{ A},$ $T_j=25\text{ }^\circ\text{C}$	-	0.82	1.2	V
Reverse recovery time	$t_{rr}$	$V_R=50\text{ V}, I_F=0.12\text{ A},$ $di_F/dt=100\text{ A}/\mu\text{s}$	-	20.5	25.6	ns
Reverse recovery charge	$Q_{rr}$		-	9.7	12.1	nC

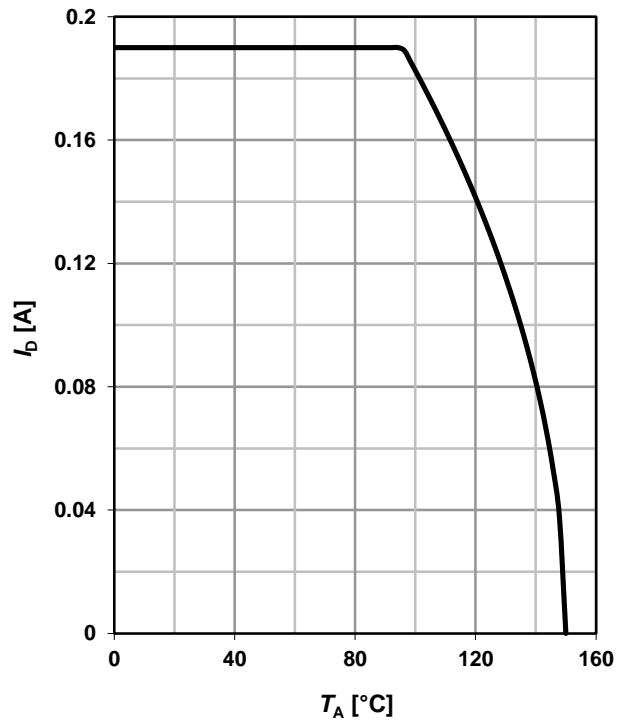
**1 Power dissipation**

$P_{tot}=f(T_A)$



**2 Drain current**

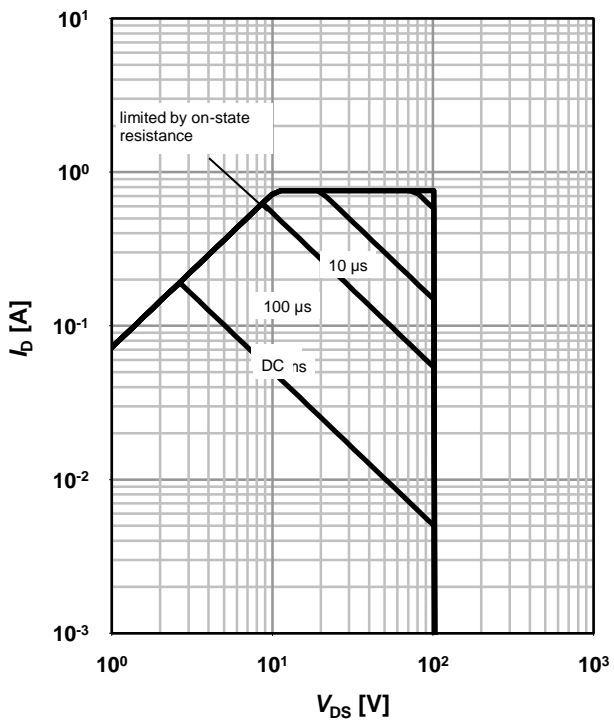
$I_D=f(T_A); V_{GS} \geq 10\text{ V}$



**3 Safe operating area**

$I_D=f(V_{DS}); T_A=25\text{ °C}; D=0$

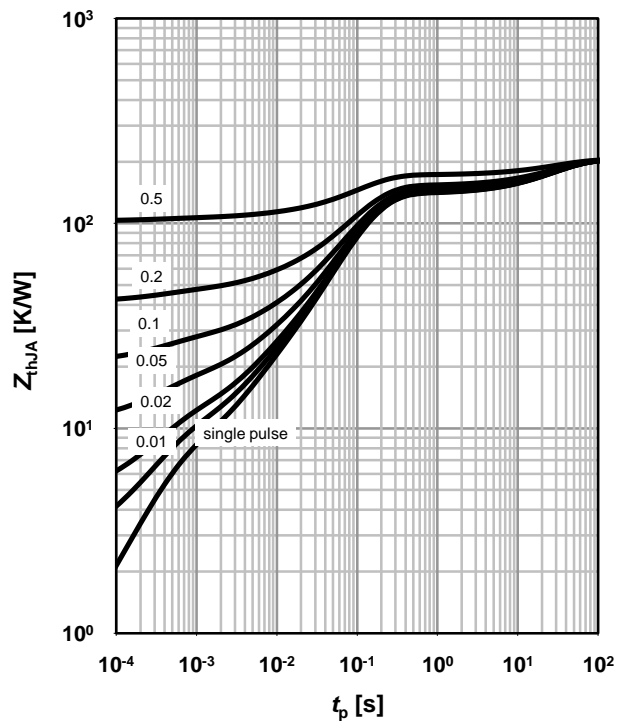
parameter:  $t_p$



**4 Max. transient thermal impedance**

$Z_{thJA}=f(t_p)$

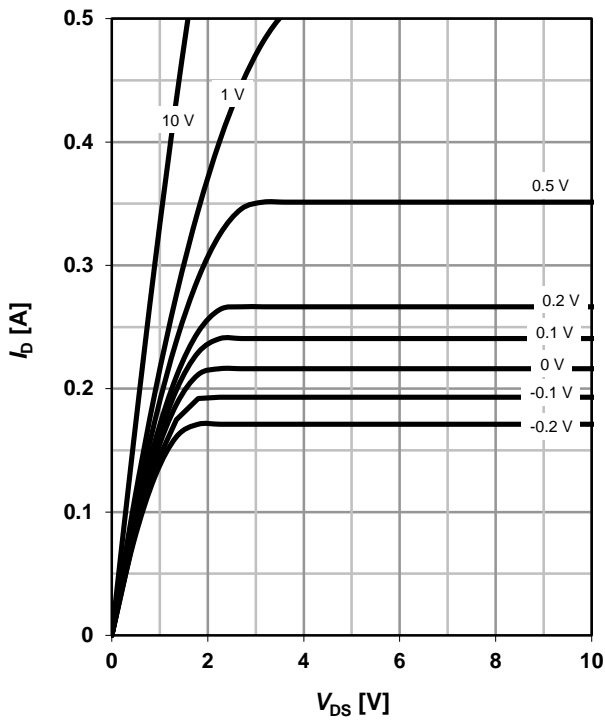
parameter:  $D=t_p/T$



**5 Typ. output characteristics**

$I_D = f(V_{DS}); T_j = 25\text{ °C}$

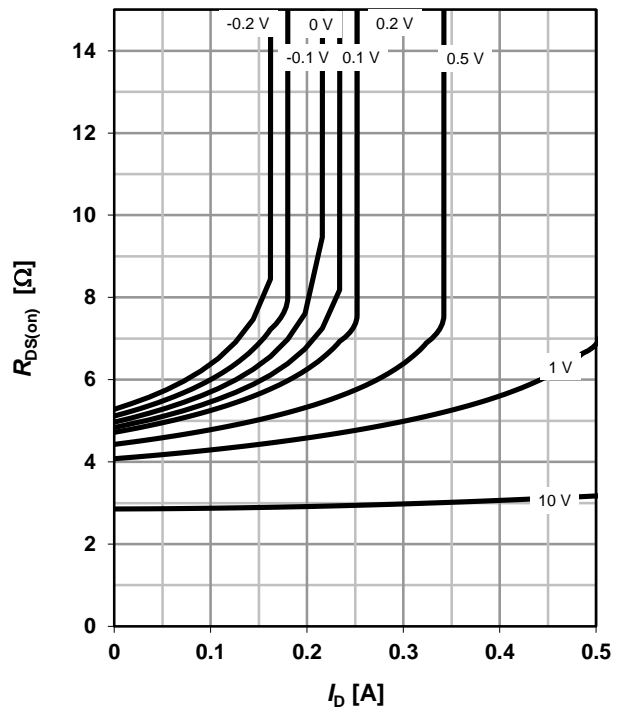
parameter:  $V_{GS}$



**6 Typ. drain-source on resistance**

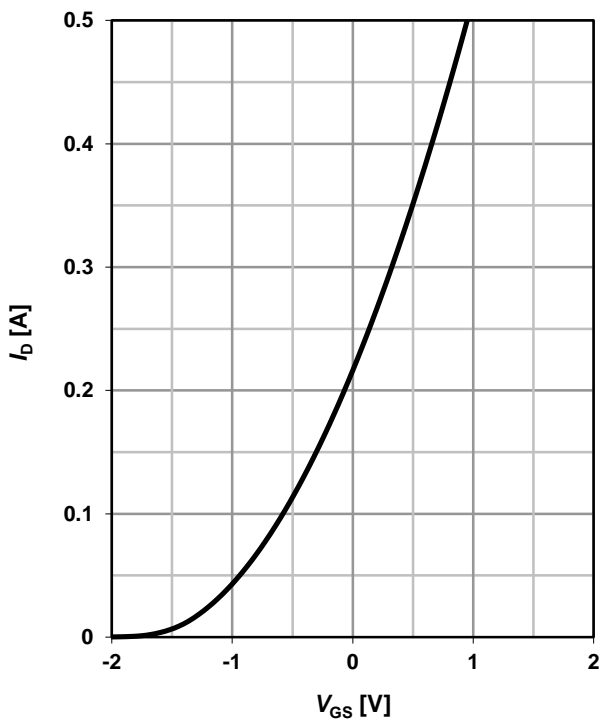
$R_{DS(on)} = f(I_D); T_j = 25\text{ °C}$

parameter:  $V_{GS}$



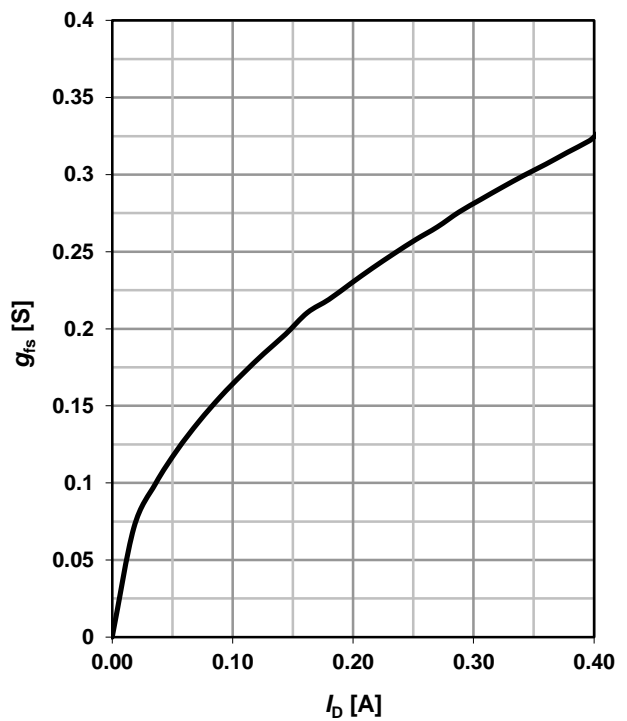
**7 Typ. transfer characteristics**

$I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)max}$



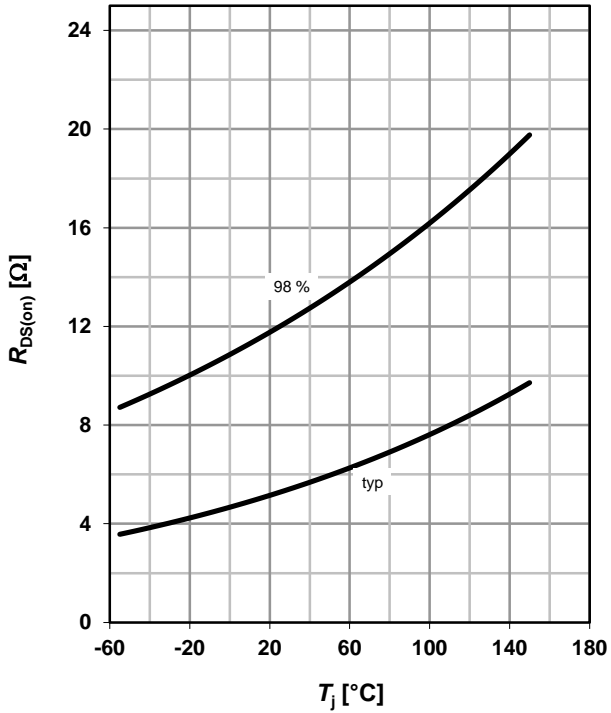
**8 Typ. forward transconductance**

$g_{fs} = f(I_D); T_j = 25\text{ °C}$



**9 Drain-source on-state resistance**

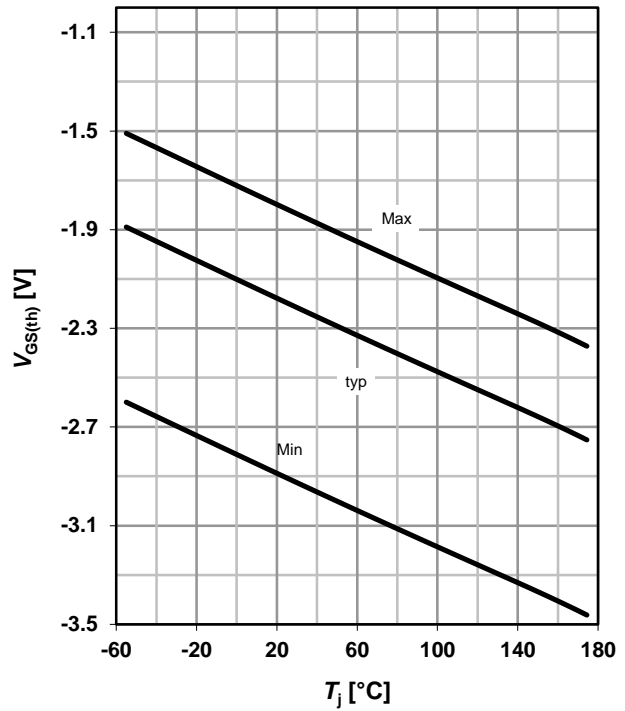
$R_{DS(on)}=f(T_j); I_D=0.05\text{ A}; V_{GS}=0\text{ V}$



**10 Typ. gate threshold voltage**

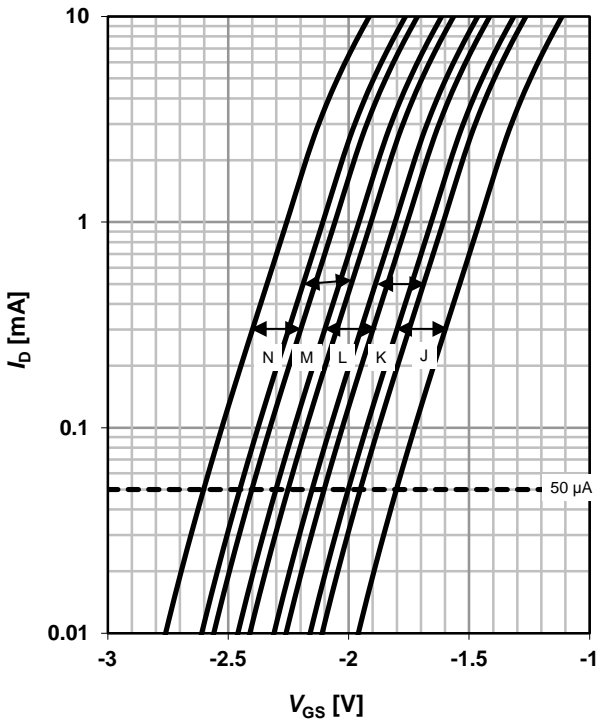
$V_{GS(th)}=f(T_j); V_{DS}=3\text{ V}; I_D=50\text{ }\mu\text{A}$

parameter:  $I_D$



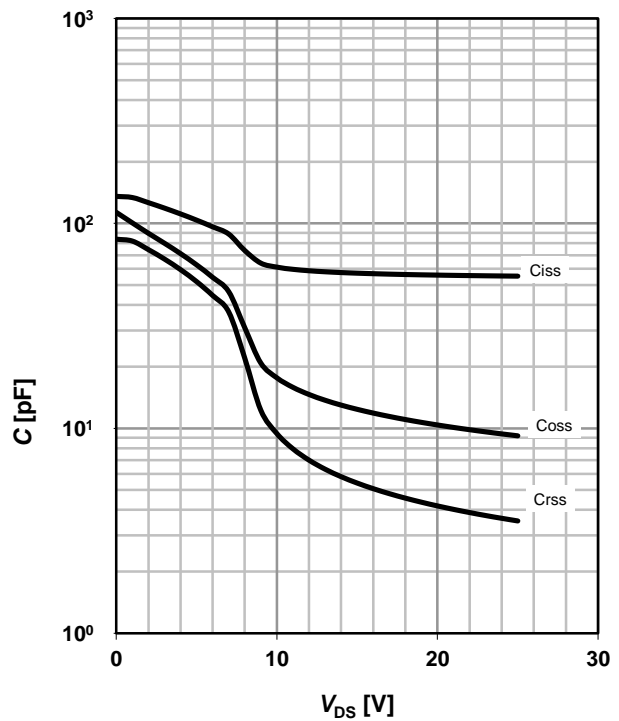
**11 Threshold voltage bands**

$I_D=f(V_{GS}); V_{DS}=3\text{ V}; T_j=25\text{ }^\circ\text{C}$



**12 Typ. capacitances**

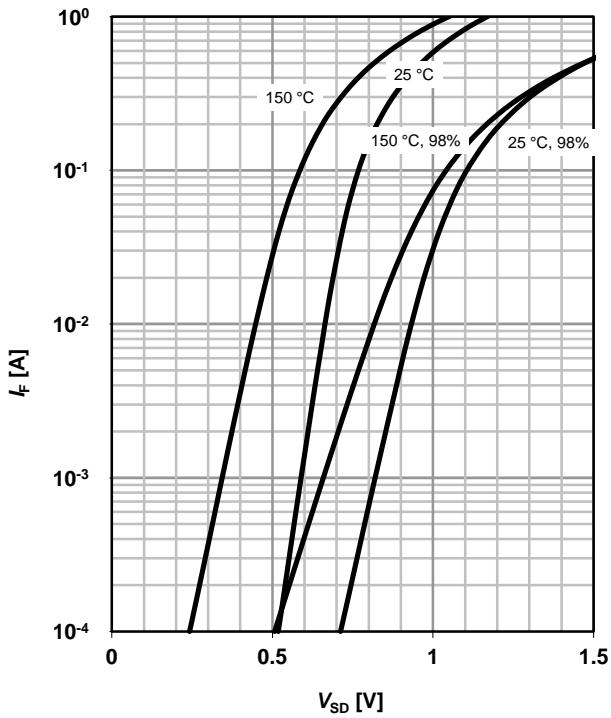
$C=f(V_{DS}); V_{GS}=-10\text{ V}; f=1\text{ MHz}$



**13 Forward characteristics of reverse diode**

$$I_F = f(V_{SD})$$

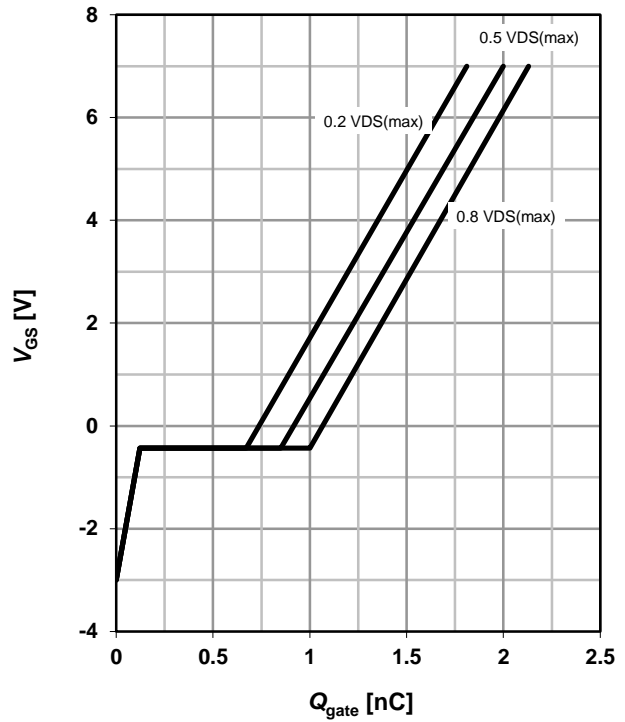
parameter:  $T_j$



**15 Typ. gate charge**

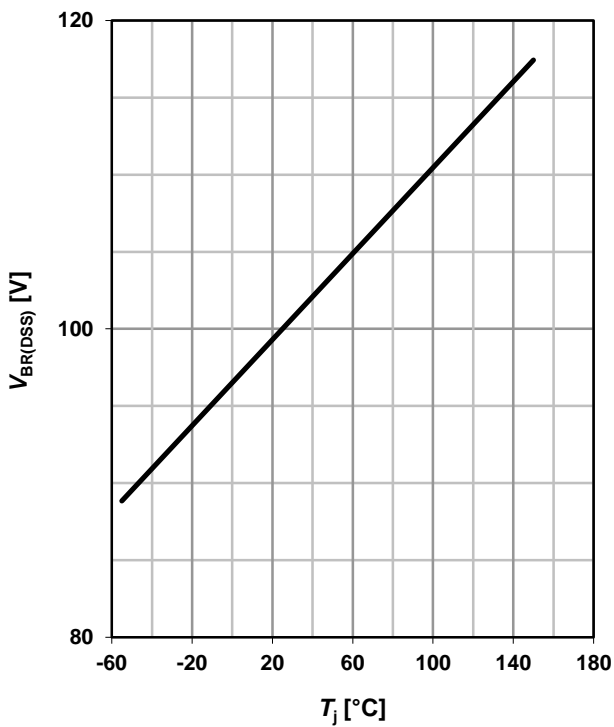
$$V_{GS} = f(Q_{gate}); I_D = 0.12 \text{ A pulsed}$$

parameter:  $V_{DD}$

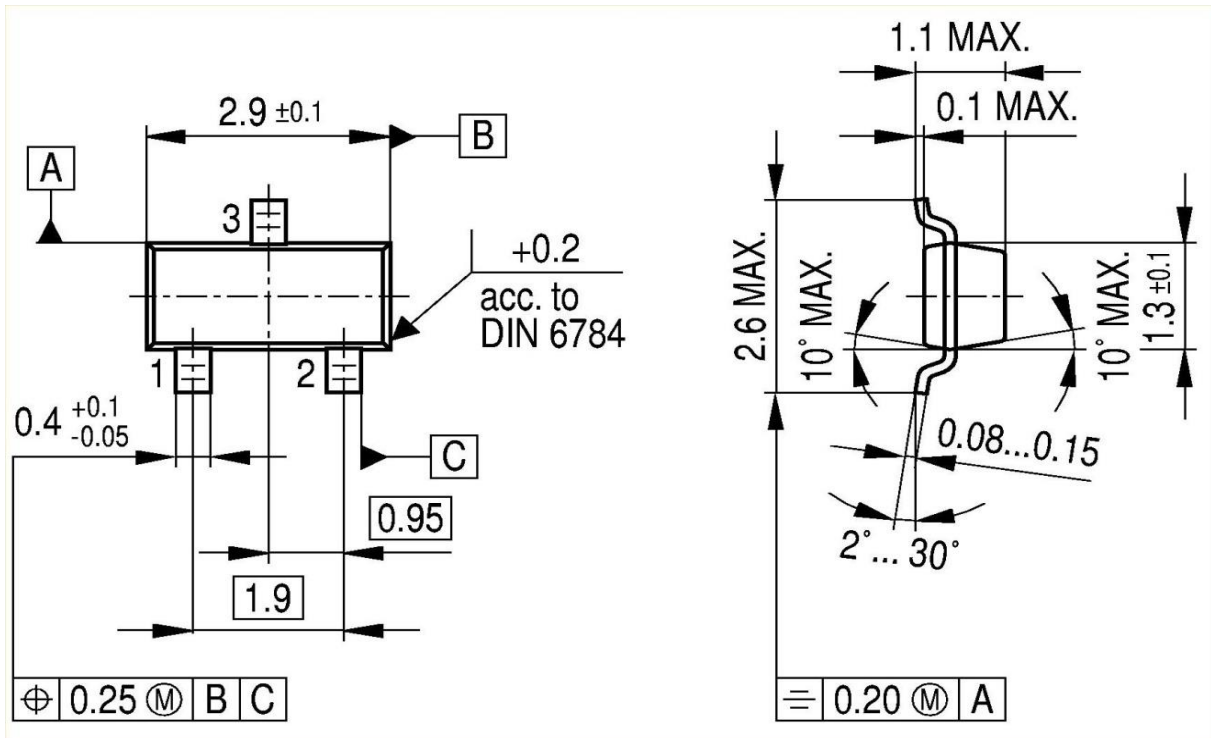


**16 Drain-source breakdown voltage**

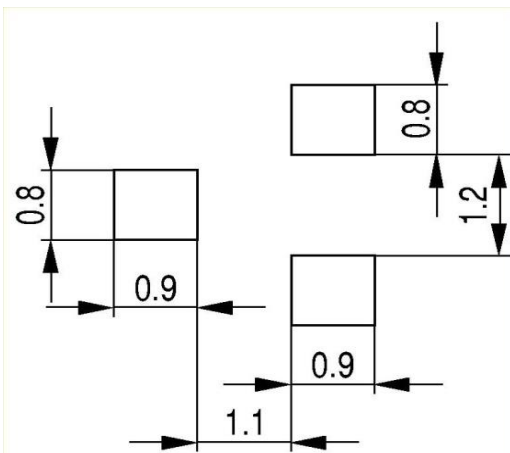
$$V_{BR(DSS)} = f(T_j); I_D = 250 \mu\text{A}$$



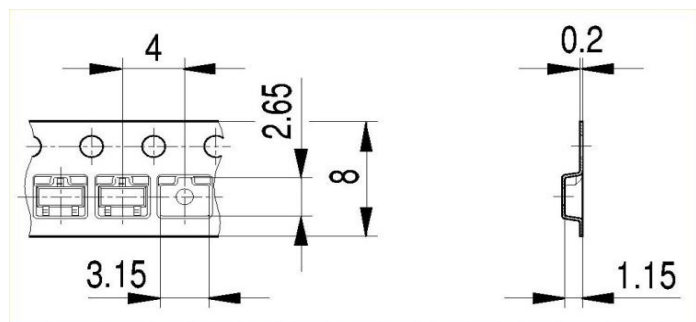
Package Outline:



Footprint:



Packaging:



Dimensions in mm



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